

PATENT 0152-0551P

THE U.S. PATENT AND TRADEMARK OFFICE

Applicant:

Hideyuki ARIYASU et al

Conf.:

7701

Appl. No.:

09/773,627

Group:

1773

Filed:

February 2, 2001

Examiner:

KRUER

For:

THERMOPLASTIC RESIN INTEGRATED

STRUCTURE

REQUEST FOR RECONSIDERATION

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 December 8, 2003

Sir:

In reply to the Office Action dated September 8, 2003, the following Remarks are respectfully submitted in connection with the above-identified application.

Ok to evter KRK 1-15-04